Device Modeling Report

COMPONENTS: OPERATIONAL AMPLIFIER (CMOS)

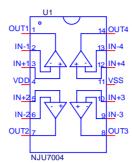
PART NUMBER: NJU7004

MANUFACTURER: NEW JAPAN RADIO



Bee Technologies Inc.

SPICE MODEL



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*$
*PART NUMBER: NJU7004
*MANUFACTURER: NEW JAPAN RADIO
*CMOS OPAMP
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.SUBCKT nju7004 IN-1 IN+1 IN-2 IN+2 VDD VSS OUT1 OUT2
+ IN-3 IN+3 IN-4 IN+4 OUT3 OUT4
X U1 IN-1 IN+1 VDD VSS OUT1 niu7004 s
X_U2 IN-2 IN+2 VDD VSS OUT2 nju7004_s
X U3 IN-3 IN+3 VDD VSS OUT3 nju7004 s
X U4 IN-4 IN+4 VDD VSS OUT4 nju7004 s
.ENDS nju7004
*$
.SUBCKT nju7004 S
                    IN- IN+ VDD VSS OUT
M1
           2 IN- 3 VDD MbreakPD3
M2
           2 IN+ 4 VDD MbreakPD2
M3
           VDD 1 2 VDD MbreakPD
M4
           VDD 1 5 VDD MbreakPD
M5
           VDD 1 6 VDD MbreakPD
           VDD 1 1 VDD MbreakPD
M6
M7
           5 5 VSS VSS MbreakND W=3.2m
                                           L=6u
M8
           5 4 VSS VSS MbreakND3
M9
           3 3 IN1 VSS MbreakND1
M10
           4 3 IN2 VSS MbreakND1
M11
           1 6 11 11 MbreakND
                                W=9m
                                         L=6u
           6 6 VSS VSS MbreakND3
M12
           7 5 VSS VSS MbreakND1
M13
M14
           VDD 7 7 VDD MbreakPD
           VDD 7 OUT VDD MbreakPD1
M15
           OUT 4 VSS VSS MbreakND2
M16
C1
          OUT 7 15p
C2
          OUT 1 10p
Cout
          OUT IN-70p
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R1
          11 VSS 1.522k
R2
          IN1 VSS 2.0k
R3
          IN2 VSS 3.93k
11
         0 IN- 0.505p
12
         0 IN+ 1.5p
X U1
          VSS 3 DbreakZ
X U2
          VSS 4 DbreakZ
.model MbreakND NMOS (LEVEL=3 VTO=0.9 RS=10.000E-3 RD=10.000E-3
+ RDS=1.0000E6 TOX=2.0000E-6 CGSO=4.000E-12 CGDO=1.000E-12
+ CBD=1.000E-12 RG=5 RB=1.0000E-3 KP=10E-6)
.model MbreakND1 NMOS (LEVEL=3 L=6u W=0.5 VTO=1 RS=10.000E-3
+ RD=10.000E-3 RDS=1.0000E6 TOX=2.0000E-6
+ CGSO=3.00E-12 CGDO=1.000E-12 CBD=1.000E-12
+ RG=5 RB=1.0000E-3 KP=10E-6)
.model MbreakND2 NMOS (LEVEL=3 L=6u W=0.483m VTO=0.9
+ RS=10.000E-3 RD=10.000E-3 RDS=1.0000E6 TOX=2.0000E-6
+ CGSO=4.000E-12 CGDO=1.00E-12 CBD=1.000E-12
+ RG=5 RB=1.0000E-3 KP=10E-6)
.model MbreakND3 NMOS (LEVEL=3 L=6u W=3.2m VTO=0.9
+ RS=10.000E-3 RD=10.000E-3 RDS=1.0000E6 TOX=2.0000E-6
+ CGSO=5.000E-7 CGDO=1.000E-13 CBD=10.000E-6
+ RG=5 RB=1.0000E-3 KP=10E-6)
.model MbreakPD PMOS (LEVEL=3 L=6u W=0.023 VTO=-1 RS=10.000E-3
+ RD=10.000E-3 RDS=1.0000E6 TOX=2.0000E-6 CGSO=4.000E-12
+ CGDO=1.000E-12 CBD=1.000E-12 RG=5 RB=1.0000E-3 KP=1E-6)
.MODEL MbreakPD1 PMOS (LEVEL=3 L=6u W=0.0056 VTO=-0.9
+ RS=10.000E-3 RD=10.000E-3 RDS=1.00E6 TOX=2.0000E-6
+ CGSO=4.000E-12 CGDO=1.000E-12 CBD=1.000E-12
+ RG=5 RB=1.0000E-3 KP=1E-6)
.MODEL MbreakPD2 PMOS (LEVEL=3 L=6u W=0.13 VTO=-1.5
+ RS=10.000E-3 RD=10.00E-3 RDS=1.00E6 TOX=2.0000E-6
+ CGSO=4.000E-12 CGDO=1.000E-12 CBD=1.00E-12
+ RG=5 RB=1.0000E-3 KP=1E-6)
.MODEL MbreakPD3 PMOS (LEVEL=3 L=6u W=0.14 VTO=-1.5
+ RS=10.000E-3 RD=10.00E-3 RDS=1.E6 TOX=2.0000E-6
+ CGSO=4.000E-12 CGDO=1.000E-12 CBD=1.00E-12
+ RG=5 RB=1.0000E-3 KP=1E-6)
.ENDS nju7004_s
```

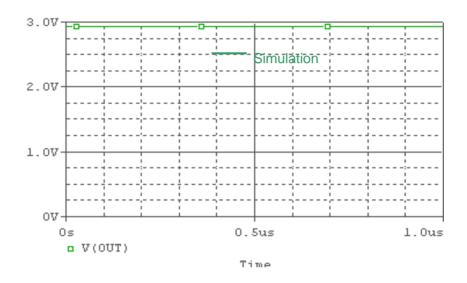
.SUBCKT DbreakZ A K
D1 A K DF
DZ A2 A DR
VZ K A2 1
.MODEL DF D
.MODEL DR D
.ENDS DbreakZ

MOSFET MODEL

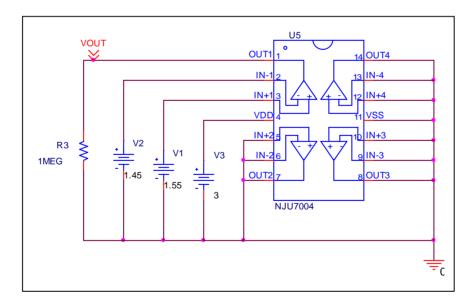
Pspice model	Model description		
parameter	·		
LEVEL			
L	Channel Length		
W	Channel Width		
KP	Transconductance		
RS	Source Ohmic Resistance		
RD	Ohmic Drain Resistance		
VTO	Zero-bias Threshold Voltage		
RDS	Drain-Source Shunt Resistance		
TOX	Gate Oxide Thickness		
CGSO	Zero-bias Gate-Source Capacitance		
CGDO	Zero-bias Gate-Drain Capacitance		
CBD	Zero-bias Bulk-Drain Junction Capacitance		
MJ	Bulk Junction Grading Coefficient		
PB	Bulk Junction Potential		
FC	Bulk Junction Forward-bias Capacitance Coefficient		
RG	Gate Ohmic Resistance		
IS	Bulk Junction Saturation Current		
N	Bulk Junction Emission Coefficient		
RB	Bulk Series Resistance		
PHI	Surface Inversion Potential		
GAMMA	Body-effect Parameter		
DELTA	Width effect on Threshold Voltage		
ETA	Static Feedback on Threshold Voltage		
THETA	Modility Modulation		
KAPPA	Saturation Field Factor		
VMAX	Maximum Drift Velocity of Carriers		
XJ	Metallurgical Junction Depth		
UO	Surface Mobility		

Output Voltage Swing

Simulation result



Evaluation Circuit



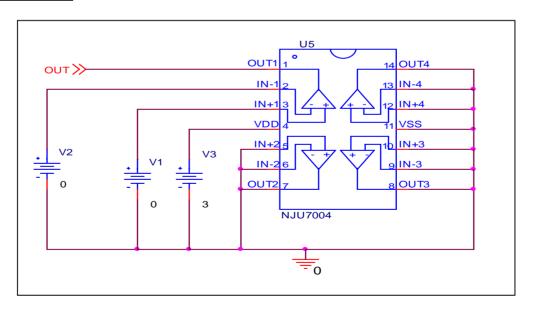
	Measurement	Simulation	%Error
V _{OM} (V)	2.940	2.939	-0.034

Input Current

Simulation result



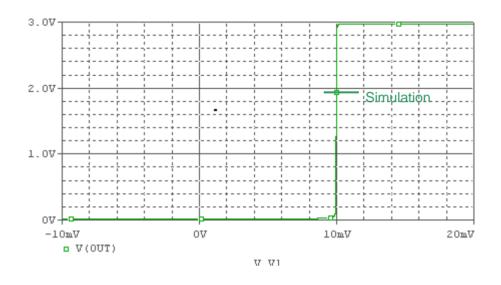
Evaluation Circuit



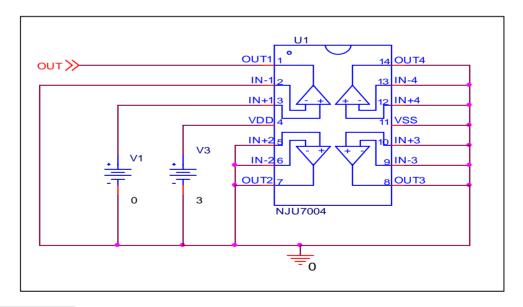
	Measurement	Simulation	% Error
I _b (pA)	1.000	1.002	0.200
I _{os} (pA)	1.000	0.995	-0.500

Input Offset Voltage

Simulation result



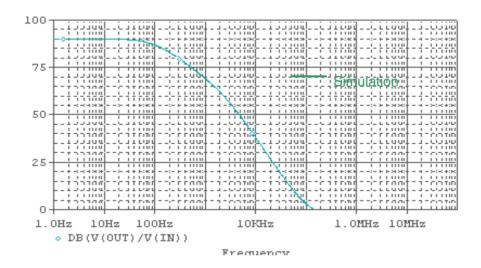
Evaluation Circuit



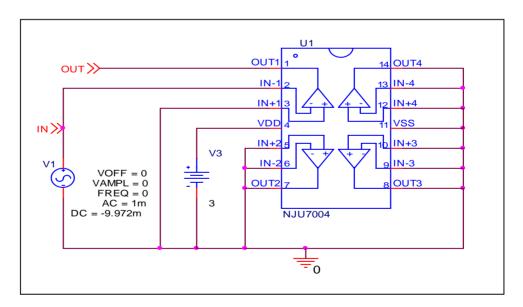
	Measurement	Simulation	%Error
Vos (mV)	10.000	9.972	-0.280

Open loop Voltage Gain

Simulation result



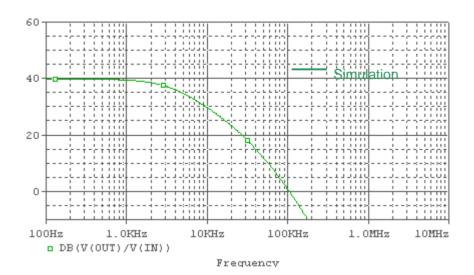
Evaluation Circuit



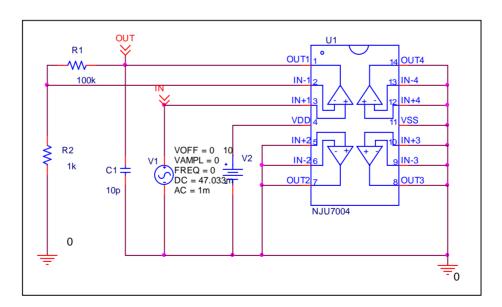
	Measurement	Simulation	%Error
Av (dB)	90.000	90.000	0

Unity Gain Frequency

Simulation result



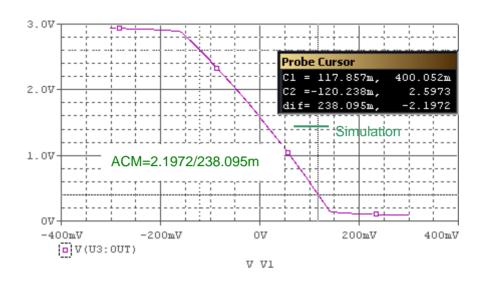
Evaluation Circuit



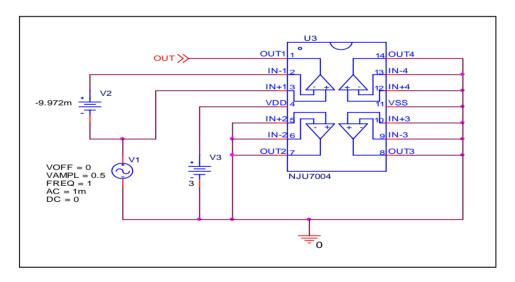
A _V =40dB,C _L =10pF	Measurement	Simulation	%Error
Ft(MHz)	0.100	0.099	-1.000

Common-Mode Rejection Ratio

Simulation result



Evaluation Circuit

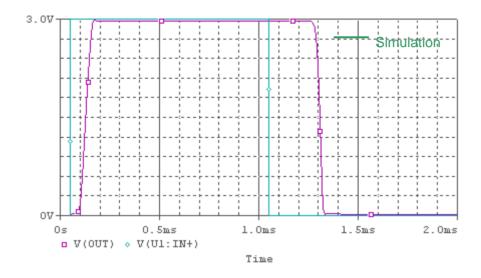


CMRR = AV/ACM

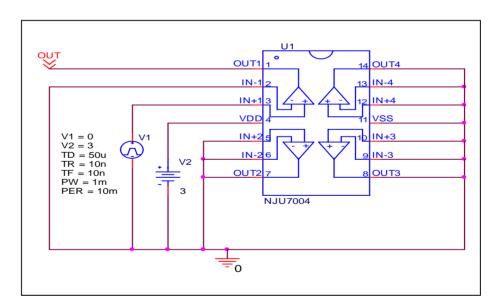
	Measurement	Simulation	%Error
CMRR (dB)	70.000	70.680	0.975

Slew Rate

Simulation result



Evaluation Circuit



	Measurement	Simulation	% Error
SR (V/us)	0.050	0.051	2.000